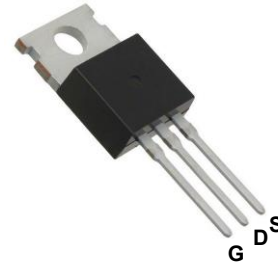


Description

The LMFB10N65 is silicon N-channel Enhanced VDMOSFETs, is obtained by the self-aligned planar Technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy. The transistor can be used in various power switching circuit for system miniaturization and higher efficiency.

Dimensions TO-220F



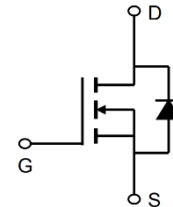
General Features

- $V_{DS} = 650V$ $I_D = 10A$
- $R_{DS(ON)} < 0.9\Omega$ @ $V_{GS}=10V$ (Typ. 0.75Ω)

Application

- Uninterruptible Power Supply(UPS)
- Power Factor Correction (PFC)

Pin Configuration



Package Marking and Ordering Information

Device	Device Marking	Device Package	Reel Size	Tape width	Quantity
LMFB10N65	AP10N65F	TO-220F	-	-	1000 units

Absolute Maximum Ratings (TC=25°C unless otherwise noted)

Symbol	Parameter	Value		Unit
		TO-220F	TO-220	
VDSS	Drain-Source Voltage ($V_{GS} = 0V$)	650		V
ID	Continuous Drain Current	10		A
IDM	Pulsed Drain Current (note1)	5.8		A
VGS	Gate-Source Voltage	± 30		V
EAS	Single Pulse Avalanche Energy (note2)	426		mJ
IAR	Avalanche Current (note1)	9		A
EAR	Repetitive Avalanche Energy (note1)	41		mJ
Pd	Power Dissipation ($T_c = 25^\circ C$)	32.1		W
TJ, Tstg	Operating Junction and Storage Temperature Range	-55~+150		°C
RthJC	Thermal Resistance, Junction-to-Case	4.46		°C/W
RthJA	Thermal Resistance, Junction-to-Ambient	46.7		°C/W

Electrical Characteristics (T_J=25°C, unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V(BR)DSS	Drain-Source Breakdown Voltage	V _{GS} = 0V, I _D = 250μA	650	685	--	V
IDSS	Zero Gate Voltage Drain Current	V _{DS} = 650V, V _{GS} = 0V, T _J = 25°C	--	--	1	μA
IGSS	Gate-Source Leakage	V _{GS} = ±30V	--	--	±100	nA
VGS(th)	Gate-Source Threshold Voltage	V _{DS} = V _{GS} , I _D = 250μA	2.0	--	4.0	V
RDS(on)	Drain-Source On-Resistance (Note3)	V _{GS} = 10V, I _D = 3.5A	--	0.75	0.9	Ω
C _{iss}	Input Capacitance	V _{GS} = 0V, V _{DS} = 25V, f = 1.0MHz	--	1037	--	pF
C _{oss}	Output Capacitance		--	138	--	
C _{rss}	Reverse Transfer Capacitance		--	5.3	--	
Q _g	Total Gate Charge	V _{DD} = 520V, I _D = 9A, V _{GS} = 10V	--	19	--	nC
Q _{gs}	Gate-Source Charge		--	7.3	--	
Q _{gd}	Gate-Drain Charge		--	8.5	--	
td(on)	Turn-on Delay Time	V _{DD} = 325V, I _D = 7A, R _G = 25Ω	--	18	--	ns
t _r	Turn-on Rise Time		--	30	--	
td(off)	Turn-off Delay Time		--	61	--	
t _f	Turn-off Fall Time		--	36	--	
IS	Continuous Body Diode Current	T _C = 25 °C	--	--	9.0	A
ISM	Pulsed Diode Forward Current		--	--	36	A
V _{SD}	Body Diode Voltage	T _J = 25°C, I _{SD} = 7A, V _{GS} = 0V	--	--	1.2	V
trr	Reverse Recovery Time	V _{GS} = 0V, I _S = 7A, di _F /dt = 100A/μs	--	431	--	ns
Q _{rr}	Reverse Recovery Charge		--	2.6	--	μC

Note :

- 1、 The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2、 The EAS data shows Max. rating . I_{AS} = 9.0A, V_{DD} = 50V, R_G = 25 Ω, Starting T_J = 25 °C
- 3、 The test condition is Pulse Test: Pulse width ≤ 300μs, Duty Cycle ≤ 1%
- 4、 The power dissipation is limited by 150°C junction temperature
- 5、 The data is theoretically the same as ID and IDM , in real applications , should be limited by total power dissipation.

Typical Electrical and Thermal Characteristics

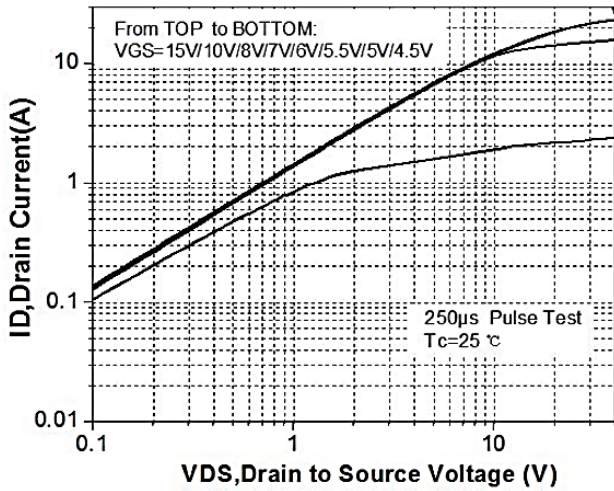


Figure 1. On-Region Characteristics

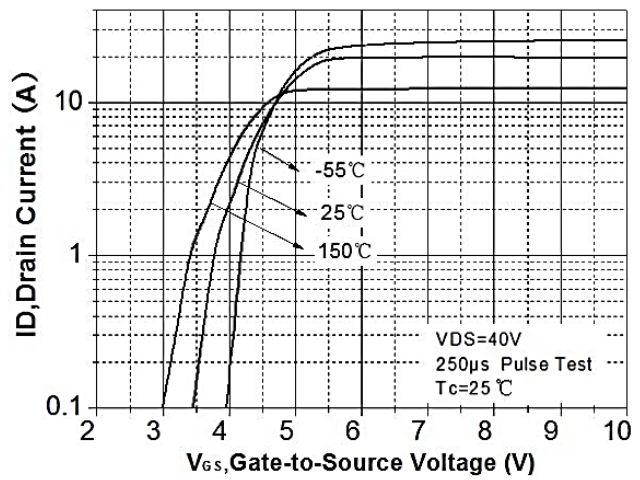


Figure 2. Transfer Characteristics

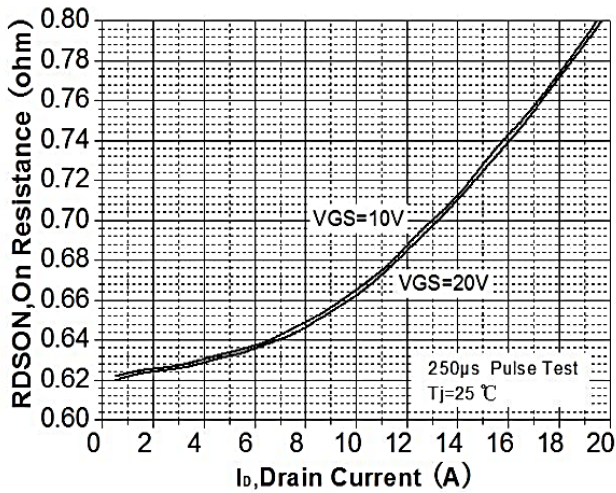


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

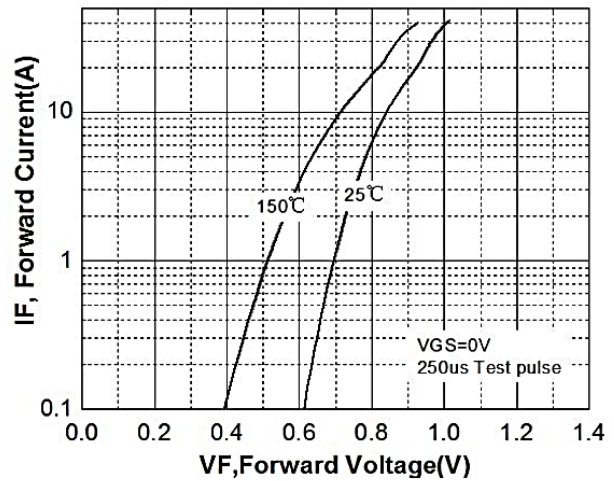


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

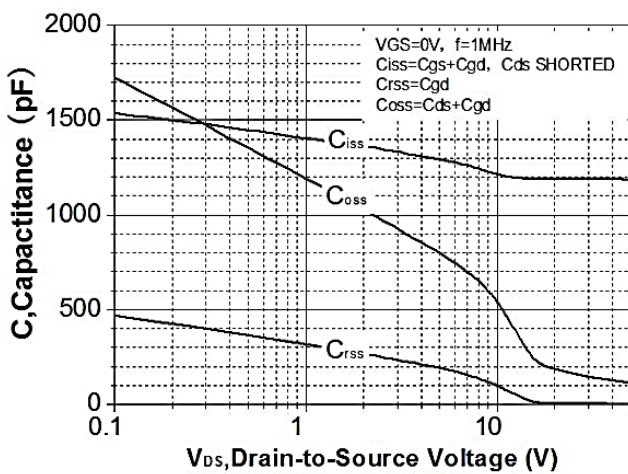


Figure 5. Capacitance Characteristics

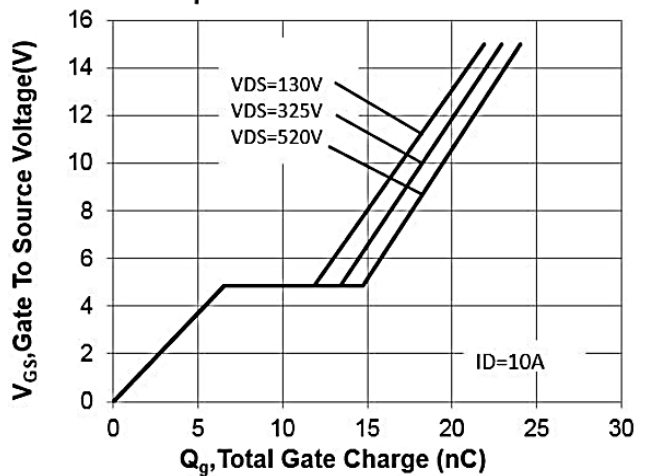


Figure 6. Gate Charge Characteristics

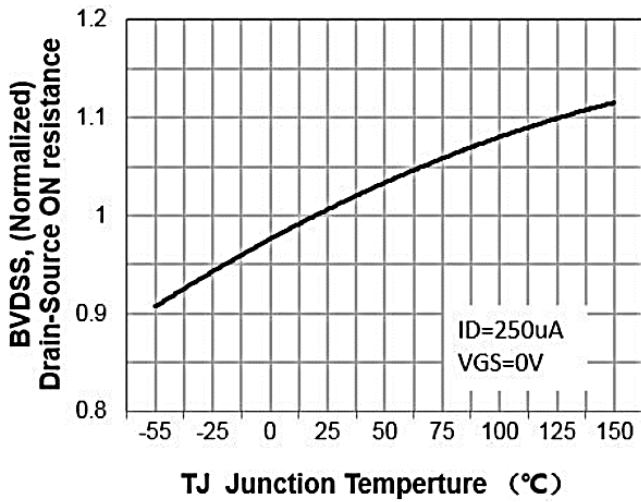


Figure 7. Breakdown Voltage Variation vs Temperature

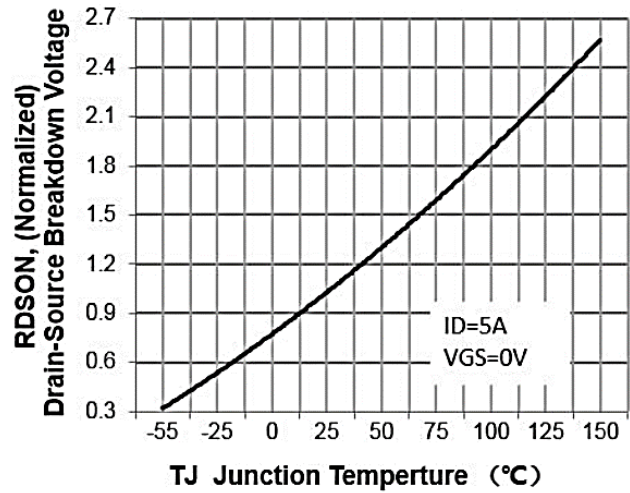


Figure 8. On-Resistance Variation vs Temperature

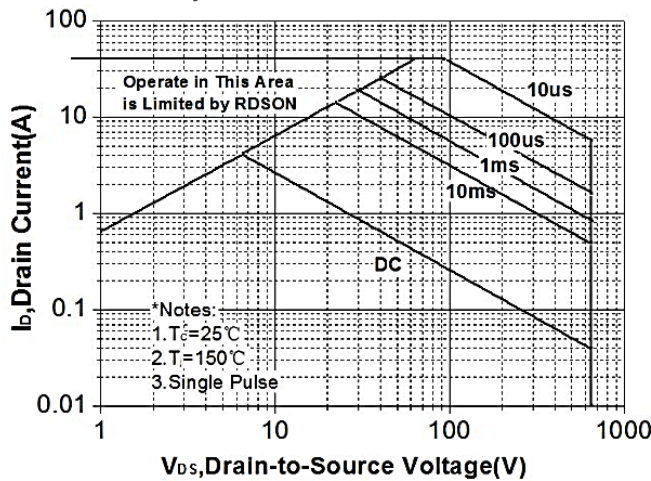


Figure 9. Maximum Safe Operating Area

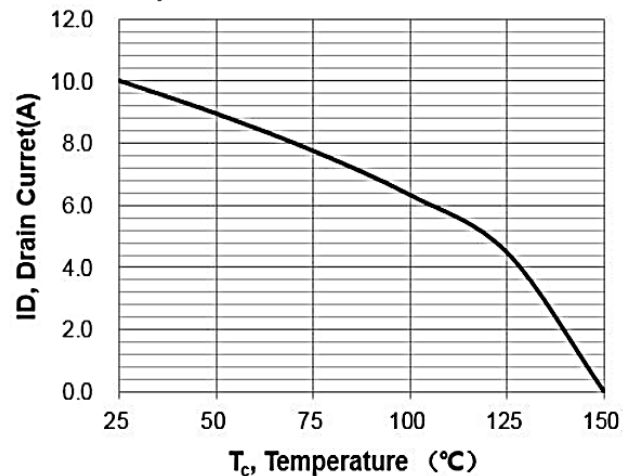


Figure 10. Maximum Drain Current vs Case Temperature

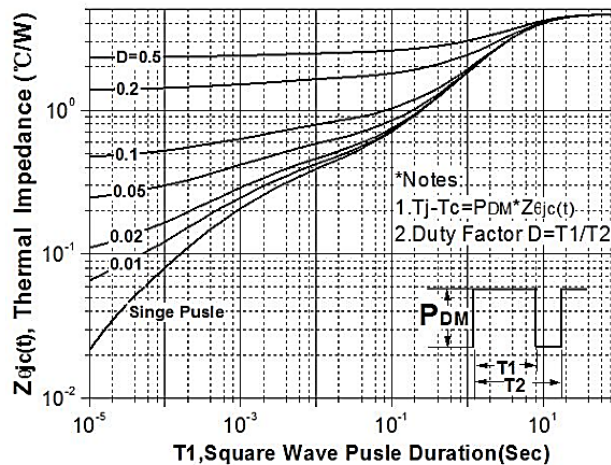
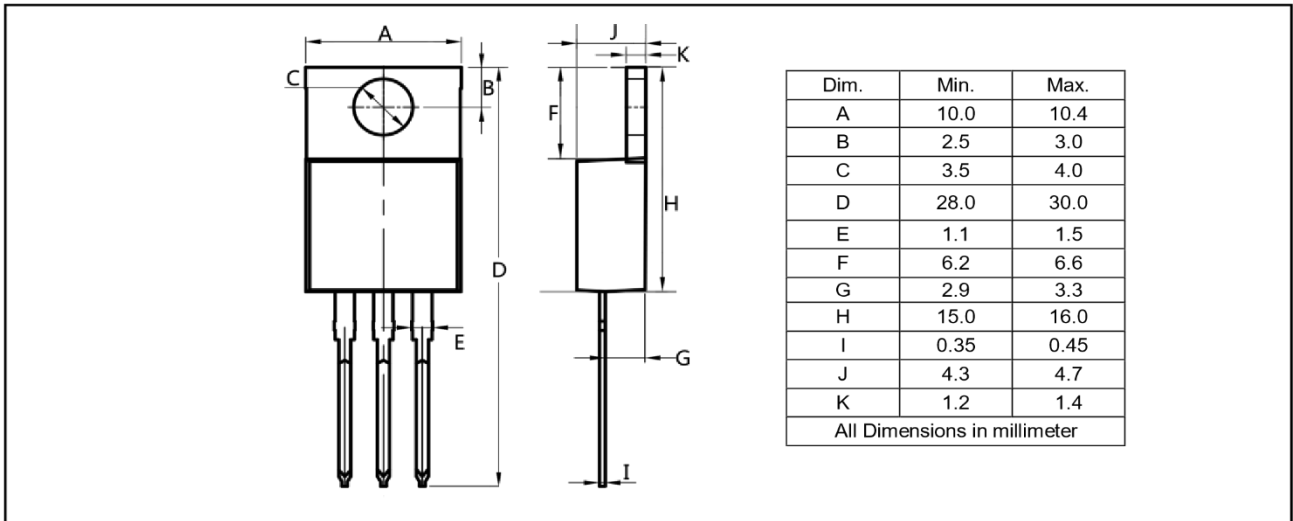


Figure 11. Transient Thermal Response Curve

TO-220F Package Information



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